附件2

**参展项目填报表(不超过9项)**

**高校名称(盖章)**

|  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- |
| 库号 | 项目名称 | 项目简介(不规过200字） | 所属领城 | 技术成熟度 | 参展形式 | 联系人 | 电话 | 邮箱 | 推荐现场展示或发布  (是/否) | 高校高价值存量专利  (是/否) | 批荐现场路演  (是/否) | 项目图片  (两张) | 备注 |
| 1 |  |  |  |  |  |  |  |  |  |  |  |  |  |
| 2 |  |  |  |  |  |  |  |  |  |  |  |  |  |
| 3 |  |  |  |  |  |  |  |  |  |  |  |  |  |
| 4 |  |  |  |  |  |  |  |  |  |  |  |  |  |
| 5 |  |  |  |  |  |  |  |  |  |  |  |  |  |
| 6 |  |  |  |  |  |  |  |  |  |  |  |  |  |
| 7 |  |  |  |  |  |  |  |  |  |  |  |  |  |
| 8 |  |  |  |  |  |  |  |  |  |  |  |  |  |
| 9 |  |  |  |  |  |  |  |  |  |  |  |  |  |